

February 2011

# FAN3989 USB/Charger Detection Device with Load Switch

#### **Features**

- Charger/USB Detection Device with Load Switch
- Charger/USB Device Detection Flag
- Over/Under-Voltage Detection Flag
- Load Switch Output, Up to 1.5A Charge Current
- V<sub>BUS</sub> Supply: 2.7V to 20V
- C<sub>ON</sub>: 1.5pF
- Package: 8-Lead MLP

# **Applications**

- Mobile Phones
- Handheld Devices

#### **Related Resources**

 AN-5067 — PCB Land Pattern Design and Surface Mount Guidelines for MLP Packages

# Description

The FAN3989 is a USB connection monitoring device used to determine if a standard USB device is connected or a battery-charging device is connected.

The FAN3989 sets the FLAG1 pin to logic HIGH or LOW as an indicator to the system controller that a standard USB device or a charger is connected to the USB port. The FAN3989 also monitors the  $V_{\text{BUS}}$  for over- or undervoltage conditions. The FLAG2 pin is set LOW if  $V_{\text{BUS}}$  is less than 3.3V or greater than 6.0V. The internal load switch control pin is set HIGH if  $V_{\text{BUS}}$  is less than 3.3V or greater than 6.0V, turning off the PMOS switch.

The FAN3989 is available in a very small 8-lead MLP package suitable for small board space applications, like mobile phones.

#### **Ordering Information**

Part Number	Operating Temperature Range	Package	Packing Method	Quantity
FAN3989MLP8X	-40°C to +85°C	8-Lead Molded Leadless Package (MLP)	Reel	3000

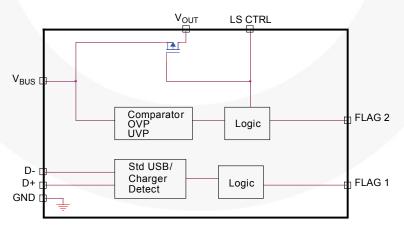
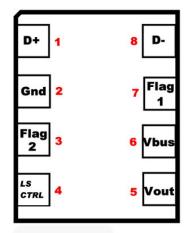


Figure 1. Block Diagram

# **Pin Configuration**



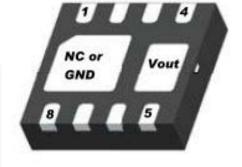


Figure 2. Pin Configuration (Top View)

Figure 3. Pin Configuration (Bottom View)

# **Pin Definitions**

Pin#	Name	Туре	Description
1	D+	Input	USB Data Input
2	GND	Input	Device Ground
3	Flag2	Output	Over-/Under-Voltage Flag Output
4	LSCTRL	Output	PMOS Switch Control – Pull-Up Connection to V <sub>BUS</sub>
5	V <sub>OUT</sub>	Output	Voltage Out – Connection also on Package DAP (see PCB Layout Guideline section)
6	V <sub>BUS</sub>	Input	Power Input from Charger, USB Device, or Handheld Battery
7	Flag1	Output	Charger / Standard USB Device Detect Flag
8	D-	Input	USB Data Input

# **Truth Table**

Connection State	V <sub>BUS</sub>	D-	D+	FLAG1	FLAG2	LS CTRL	Description
STD USB Device	0V	R to GND	R to VDD	LOW	LOW	HIGH	Load switch open
STD USB Device	5V	R to GND	R to VDD	LOW	HIGH	LOW	Load switch closed
USB Charger	5V	Short to D+	Short to D-	HIGH	HIGH	LOW	Normal state, load switch closed
V <sub>BUS</sub> GT 6V	GT 6V	Short to D+	Short to D-	HIGH	LOW	HIGH	Load switch open
V <sub>BUS</sub> LT 3.3V	LT 3.3V	Short to D+	Short to D-	HIGH	LOW	HIGH	Load switch open
PC Charger	5V	Open	Open	LOW	HIGH	LOW	Load switch closed

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
Vs	DC Supply Voltage	-0.3	20.0	V
$V_{IO}$	Analog and Digital I/O	-0.3	V <sub>CC</sub> +0.3	V

# **Reliability Information**

Symbol	Parameter	Min.	Тур.	Max.	Unit
T <sub>J</sub>	Junction Temperature			+150	°C
T <sub>STG</sub>	Storage Temperature Range	-65		+150	°C
$\Theta_{JA}$	Thermal Resistance, JEDEC Standard, Multilayer Test Boards, Still Air		41		°C/W

# **Electrostatic Discharge Information**

Symbol	Parameter	Max.	Unit
ESD.	Human Body Model, JESD22-A114		14) /
ESD	Charged Device Model, JESD22-C101		kV

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

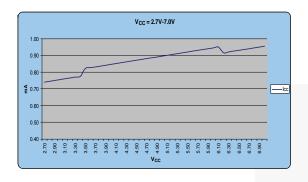
Symbol	Parameter	Min.	Тур.	Max.	Unit
T <sub>A</sub>	Operating Temperature Range	-40		+85	°C
V <sub>cc</sub>	Supply Voltage Range	2.7	5.0	20.0	V

### **DC Electrical Characteristics**

 $T_A$  = 25°C,  $V_{CC}$  = 5.0V, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units	
Supply	Supply						
Vs	Supply Voltage Range	V <sub>S</sub> Range	2.7	5.0	20.0	V	
I <sub>CC</sub>	Quiescent Supply Current	$V_S$ = +5.0V, D+ D- Shorted		1.2	2.0	mA	
t <sub>SUPPLY</sub>	Power-Up Stabilization Time	$V_S$ = +5.0V, D+ D- Shorted		10		ms	
Input Charac	cteristics						
C <sub>D+</sub>	Input Capacitance			1.5	2.0	pF	
C <sub>D-</sub>	Input Capacitance			1.5	2.0	pF	
I <sub>off</sub> D+	Off Leakage Current	$V_{BUS}$ = 0V or 5V $V_{IN}$ on D+ = 5V		1		μA	
I <sub>off</sub> D-	Off Leakage Current	$V_{BUS}$ = 0V or 5V $V_{IN}$ on D- = 5V		1		μA	
Output Char	acteristics						
OV <sub>DETECT</sub>	Over-Voltage Threshold Detect	V <sub>S</sub> = +5.0V, Flag2 = LOW	5.8	6.2	6.5	V	
OV <sub>HYST</sub>	Over-Voltage Hysteresis	Voltage Sweep through Upper and Lower Trip Points		100		mV	
UV <sub>DETECT</sub>	Under-Voltage Threshold Detect	V <sub>S</sub> = +5.0V, Flag2 = LOW	3.0	3.3	3.6	V	
UV <sub>HYST</sub>	Under-Voltage Hysteresis	Voltage Sweep through Upper and Lower Trip Points		100		mV	
V <sub>OH</sub> FLAG1/ FLAG2	Minimum HIGH Output Voltage	V <sub>S</sub> = +5.0V, I <sub>OH</sub> = -20μA	2.4			V	
V <sub>OL</sub> FLAG1/ FLAG2	Maximum LOW Output Voltage	V <sub>S</sub> = +5.0V, I <sub>OL</sub> = 20μA			0.3	V	
V <sub>OL</sub> LS_CTRL	Maximum LOW Output Voltage	V <sub>S</sub> = +5.0V, I <sub>OL</sub> = 100μA			0.3	V	
VB <sub>DSS</sub>	Drain Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	-20			V	
R <sub>DSON</sub>	Static Drain-Source On Resistance	V <sub>GS</sub> = -5.0V, I <sub>P</sub> = 1A		186		mΩ	
C <sub>iss</sub>	Input Capacitance			330		pF	
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -10V, V_{GS} = 0V, f = 1.0MHz$	/.	80		pF	
t <sub>d(on)</sub>	PMOS Turn-On Delay Time	$V_{DD} = -5V, I_P = -0.5A,$		5		μs	
t <sub>d(off)</sub>	PMOS Turn-Off Delay Time	$V_{GS} = -4.5V$ , $R_{GEN} = 6\Omega$		14		μs	

# Typical Performance Characteristics



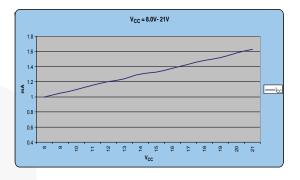


Figure 4. I<sub>CC</sub> vs. V<sub>CC</sub> (2.7V-7.0V) No Load

Figure 5.  $I_{CC}$  vs.  $V_{CC}$  (8.0V-21V) No Load

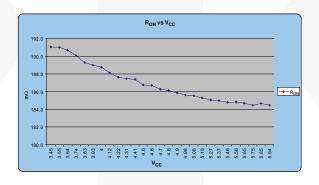


Figure 6.  $R_{ON}$  vs.  $V_{CC}$  (10 $\Omega$  Load)

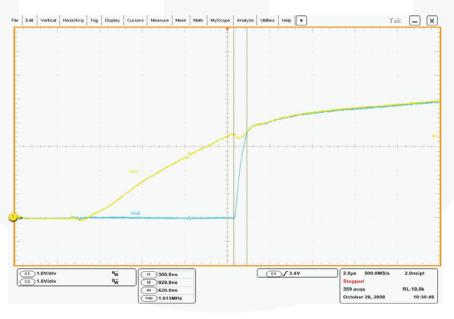


Figure 7. Turn-On Time

# Typical Performance Characteristics (Continued)

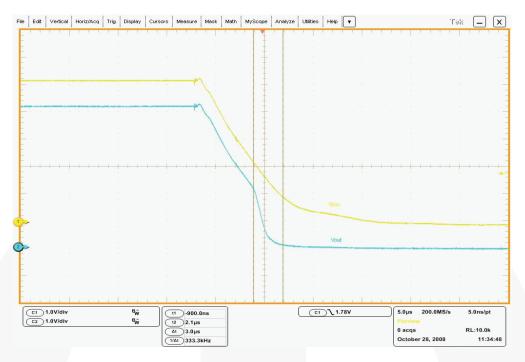


Figure 8. Turn-Off Time

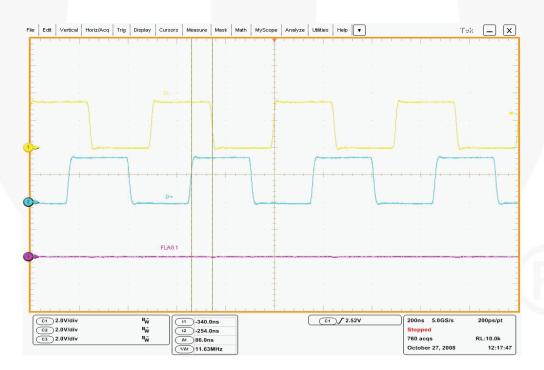
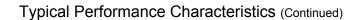


Figure 9. No Fault on Flag 1, Skew=65ns



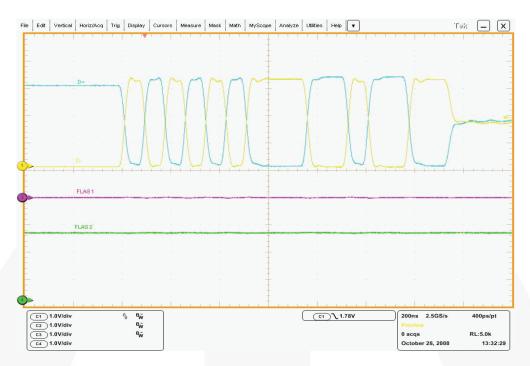


Figure 10. PC Data Running D+/D- (Flag 1 and Flag 2 at Correct Levels)

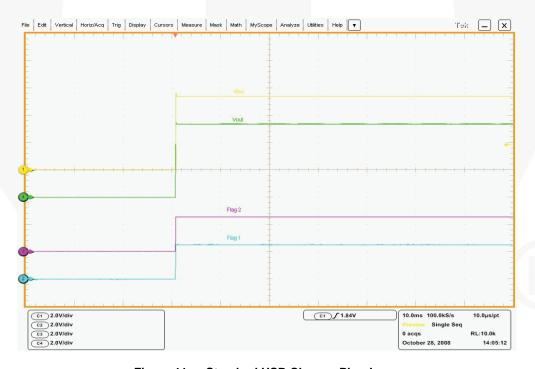


Figure 11. Standard USB Charger Plug-In

# **Applications Information**

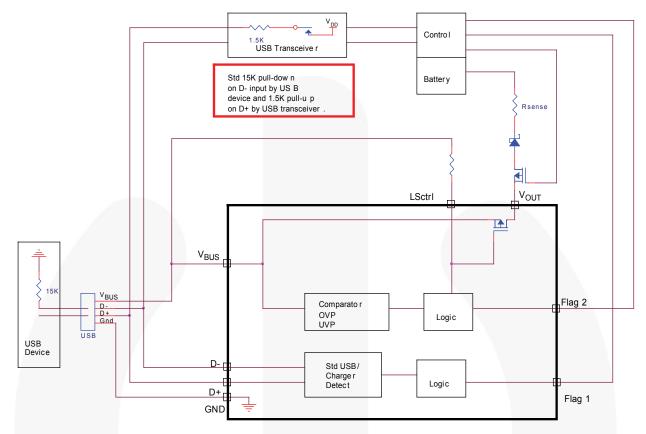


Figure 12. Mobile Phone Battery Charging System with USB Interface

The FAN3989 sets the FLAG1 pin to logic HIGH or LOW as an indicator to the system controller that a standard USB device or a charger is connected to the USB port. The FAN3989 also monitors the  $V_{BUS}$  for over- or under-voltage conditions. If  $V_{BUS}$  is less than 3.3V or greater than 6.0V, the FLAG2 pin is set LOW and the internal load switch control pin is set HIGH, turning off the PMOS switch.

In a standard USB configuration, there is a switch in the USB transceiver that is always on in full-speed mode. It is on during the transition from full-speed to high-speed mode and turned off after enumeration is complete. If D+ and D- are shorted when a charger is plugged into the USB port, the USB switch is on and pulled to  $V_{\text{DD}},$  which is about 3V, making both D+ and D- HIGH. Flag1 is also set HIGH, indicating that a charging device is connected to the port. If D+ and D-are connected to a standard USB device, the D+ is pulled to  $V_{\text{DD}}$  and D- is set low (due to the 15K $\Omega$  pull-down resistor on the USB device) and flag1 is LOW. If D+ and D- are open (floating), D+ is pulled to  $V_{\text{DD}}$  and D- floats LOW, which makes flag1 LOW.

# **Applications Information (Continued)**

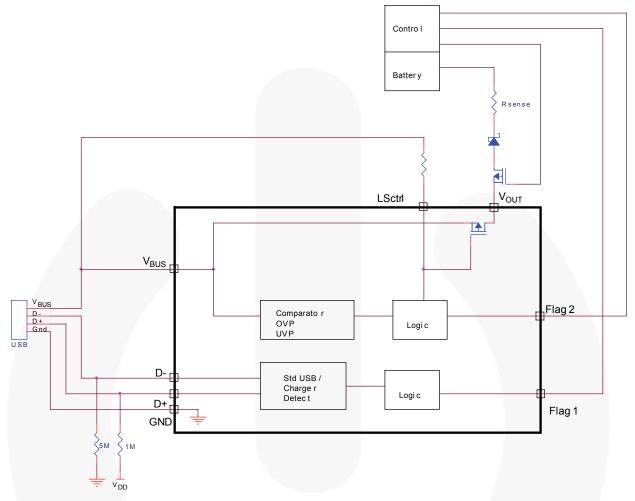


Figure 13. Mobile Phone Battery Charging System without USB Interface

The FAN3989 sets the FLAG1 pin to logic HIGH or LOW as an indicator to the system controller that a standard USB device or a charger is connected to the USB port. The FAN3989 also monitors the  $V_{BUS}$  for over- or under-voltage conditions. If  $V_{BUS}$  is less than 3.3V or greater than 6.0V, the FLAG2 pin is set LOW and the internal load switch control pin is set HIGH, turning off the PMOS switch.

Where a USB transceiver is not incorporated or there is a switch between the USB port and the FAN3989, external resistors are used to set the correct input logic states on the D+ and D- inputs. A 5M $\Omega$  pull-down on the D- line and a 1M $\Omega$  pull-up to V<sub>DD</sub> on the D+ line are recommended. If a charger is plugged into

the USB port (D+ and D- shorted), the voltage divider of 1M and 5M put a voltage of 2.3V on the D+D-inputs and flag1 is HIGH, indicating a charger is connected to port.

If the USB port is connected to a standard USB device, the D+ input is pulled up to  $V_{DD}$  and is in parallel with the  $1.5 K\Omega$  on a USB transceiver with a parallel R value of  $1.497 K\Omega.$  The D- input is connected to a  $15 K\Omega$  pull-down by the USB device and in parallel with  $5 M\Omega$  with a parallel R value of  $14.955 K\Omega.$  This condition forces flag1 LOW. If D+ and D- are open (floating), D+ is pulled to  $V_{DD}$  and D-floats LOW, which forces flag1 LOW.

# **PCB Layout Guidelines**

Please also see Fairchild Semiconductor applications note AN-5067 — PCB Land Pattern Design and Surface Mount Guidelines for MLP Packages

#### Pad1

This exposed DAP is connected to the internal FET drain and labeled  $V_{\text{OUT}}$  on the device. The pad should be connected to  $V_{\text{OUT}}$  pin of the device or left floating. It

should never be connected to the ground, power plane, or Pad2.

#### Pad2

This exposed DAP is connected to an internal die substrate that is at a ground potential. The pad should be left floating or can be connected to ground plane. This pad should never be connected to Pad1 or the power plane.

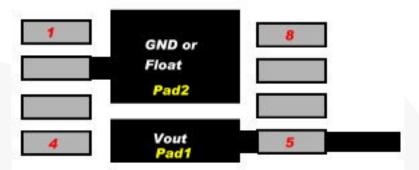
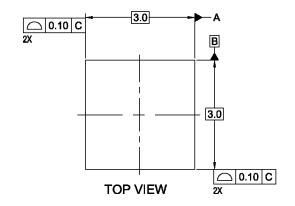
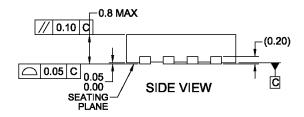
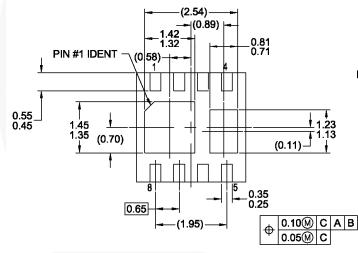


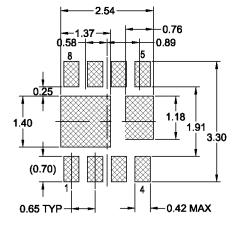
Figure 14. PCD / Pad Layout

# **Physical Dimensions**









RECOMMENDED LAND PATTERN (NSMD PAD TYPE)

#### NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION VEEC, DATED 11/2001
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- D. LAND PATTERN RECOMMENDATION IS BASED ON FSC DESIGN ONLY
- E. DRAWING FILENAME: MKT-MLP08Erev2.

Figure 15. 8-Lead Molded Leadless Package (MLP)

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#### Definition of Terms

Definition of Terms				
Datasheet Identification Product Status		Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 153

# AMEYA360 Components Supply Platform

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